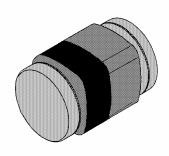
SILICON EPITAXIAL PLANAR DIODE

LS-31

fast switching diode in MiniMELF case especially suited for automatic surface mounting.



Absolute Maximum Ratings (T_a = 25°C)

	Symbol	Value	Unit			
Reverse Voltage	V _R	75	V			
Peak Reverse Voltage	V _{RM}	100	V			
Rectified Current (Average) Half Wave Rectification with Resist. Load at $T_{amb} = 25^{\circ}$ C and f/50 H _Z	I _O	150 ¹⁾	mA			
Surge Forward Current at t<1s and $T_j = 25^{\circ}C$	I _{FSM}	500	mA			
Power Dissipation	P _{tot}	500 ¹⁾	mW			
Junction Temperature	Tj	175	°C			
Storage Temperature Range	Ts	-65 to +175	°C			
¹⁾ Valid provided that electrodes are kept at ambient temperature.						

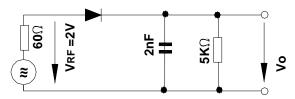






Characteristics at $T_j = 25^{\circ}C$

	Symbol	Min.	Тур.	Max.	Unit	
Forward Voltage at $I_F = 5mA$ at $I_F = 100mA$	V _F V _F	0.62 -	-	0.72 1	V V	
Leakage Current at $V_R = 20V$ at $V_R = 75V$ at $V_R = 20V$, $T_j = 150^{\circ}C$	I _R I _R I _R	- - -	- - -	25 5 50	nA μA μA	
Reverse Breakdown Voltage tested with 100µA Pulses	V _{(BR)R}	100	-	-	V	
Capacitance at $V_F = V_R = 0$	C _{tot}	-	-	4	pF	
Reverse Recovery Time from $I_F = 10$ mA to $I_R = 1$ mA, $V_R = 6$ V, $R_L = 100\Omega$	t _{rr}	-	-	4	ns	
Thermal Resistance Junction to Ambient Air	R _{thA}	-	-	0.35 ¹⁾	K/mW	
Rectification Efficiency at f = 100MHz, $V_{RF} = 2V$	η_{v}	0.45	-	-	ns-	
¹⁾ Valid provided that electrodes are kept at ambient temperature.						



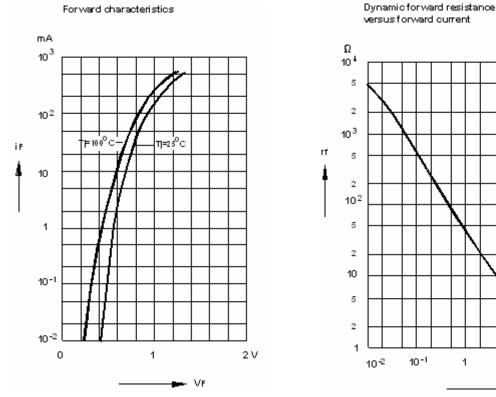
Rectification Efficiency Measurement Circuit





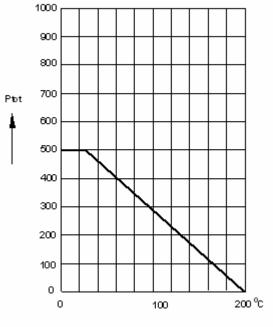


MCL4448



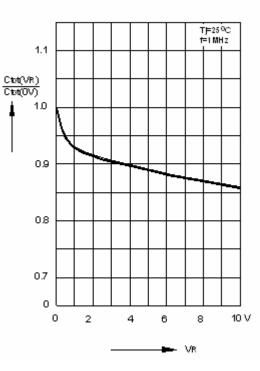
versus forward current T)=25 ℃ f=1KHz 10² mA 1 10 - IF

Admissible power dissipation versus ambient temperature Valid provided that leads at a distance of 8 mm from case are kept at amblent temperature m₩



Tamb

Relative capacitance versus reverse voltage





SEMTECH ELECTRONICS LTD. (Subsidiary of Sino-Tech International Holdings Limited, a company listed on the Hong Kong Stock Exchange, Stock Code: 724)



